

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6007570

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHENGANG FENG	03/09/2020
HANDOKO LINEWIH	03/09/2020
YANXIA SHAO	03/09/2020
YUDI SETIAWAN	03/06/2020
RECEIVING PARTY DATA	
Name:	GLOBALFOUNDRIES SINGAPORE PTE. LTD.
Street Address:	60 WOODLANDS INDUSTRIAL PARK D STREET 2
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	738406
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16813835
CORRESPONDENCE DATA	
Fax Number:	(617)849-5451
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	globalfoundries@vjp.de
Correspondent Name:	VIERING, JENTSCHURA & PARTNER MBB
Address Line 1:	C/O 444 BRICKELL AVENUE, SUITE 700
Address Line 4:	MIAMI, FLORIDA 33131
ATTORNEY DOCKET NUMBER:	P117506US
NAME OF SUBMITTER:	NATALIE A. LEE
SIGNATURE:	/Natalie A. Lee, Reg.# 67,023/
DATE SIGNED:	03/11/2020
Total Attachments: 4	
source=P117506US_Assignment#page1.tif	
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COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	THIN FILM BASED SEMICONDUCTOR DEVICES AND METHODS OF FORMING A THIN FILM BASED SEMICONDUCTOR DEVICE
<p style="text-align: center;">DECLARATION</p> <p>As the below named inventor, I hereby declare that:</p> <p>This declaration is directed to: <input checked="" type="checkbox"/> The attached application, or</p> <p style="margin-left: 150px;"><input type="checkbox"/> United States application or PCT international application number _____ filed on _____</p> <p>The above-identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p> <p>I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.</p> <p style="text-align: center;">ASSIGNMENT</p> <p>For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.</p> <p>If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.</p>	
<p>LEGAL NAME OF INVENTOR</p> <p>Inventor: <u>Chengang FENG</u> Date: <u>9 Mar 2020</u></p> <p>Signature: <u>[Handwritten Signature]</u></p>	
<p><small>Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.</small></p>	

COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

**Title of
Invention**

THIN FILM BASED SEMICONDUCTOR DEVICES AND METHODS OF FORMING A THIN FILM BASED SEMICONDUCTOR DEVICE

DECLARATION

As the below named inventor, I hereby declare that:

This declaration is directed to: ☒ The attached application, or

☐ United States application or PCT international application number _____ filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.

ASSIGNMENT

For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.

If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.

LEGAL NAME OF INVENTOR

Inventor: Handoko LINEWIH Date: 9/03/2020

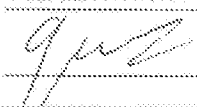
Date: 3/03/2020.

Signature: H. A. Cole

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.

REFERENCES

COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

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ASSIGNMENT	
<p>For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.</p> <p>If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.</p>	
LEGAL NAME OF INVENTOR	
Inventor:	Yudi SETIAWAN
Date:	6 March 2020
Signature:	
<p>Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.</p>	

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